

September 1983 Revised February 1999

MM74HC164 8-Bit Serial-in/Parallel-out Shift Register

General Description

The MM74HC164 utilizes advanced silicon-gate CMOS technology. It has the high noise immunity and low consumption of standard CMOS integrated circuits. It also offers speeds comparable to low power Schottky devices.

This 8-Bit shift register has gated serial inputs and CLEAR. Each register bit is a D-type master/slave flip-flop. Inputs A & B permit complete control over the incoming data. A LOW at either or both inputs inhibits entry of new data and resets the first flip-flop to the low level at the next clock pulse. A high level on one input enables the other input which will then determine the state of the first flip-flop. Data at the serial inputs may be changed while the clock is HIGH or LOW, but only information meeting the setup and hold time requirements will be entered. Data is serially shifted in and out of the 8-Bit register during the positive going transi-

tion of the clock pulse. Clear is independent of the clock and accomplished by a low level at the CLEAR input.

The 74HC logic family is functionally as well as pin-out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

- Typical operating frequency: 50 MHz
- Typical propagation delay: 19 ns (clock to Q)
- Wide operating supply voltage range: 2–6V
- Low input current: 1 μA maximum
- Low quiescent supply current: 80 µA maximum (74HC Series)
- Fanout of 10 LS-TTL loads

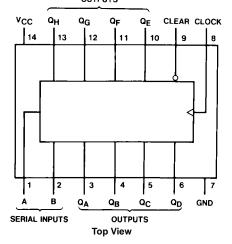
Ordering Code:

Order Number	Package Number	Package Description
MM74HC164M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
MM74HC164MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC164N	Ν14Δ	14-Lead Plastic Dual-In-Line Package (PDIP) IEDEC MS-001 0 300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram

Pin Assignments for DIP, SOIC and TSSOP



Truth Table

Inputs				Outputs				
Clear	Clock	Α	В	Q_A	Q_B		Q _H	
L	Х	Х	Χ	L	L		L	
Н	L	Χ	Χ	Q_{AO}	Q_{BO}		Q_{HO}	
Н	1	Н	Н	Н	Q_{An}		Q_{Gn}	
Н	1	L	Χ	L	Q_{An}		Q_Gn	
Н	1	Χ	L	L	Q_{An}		Q_Gn	

- H = HIGH Level (steady state), L = LOW Level (steady state)
- X = Irrelevant (any input, including transitions)
- ↑ = Transition from LOW-to-HIGH level.

 $Q_{AO},\,Q_{BO},\,Q_{HO}=\text{the level of }Q_A,\,Q_B,\,\text{or }Q_H,\,\text{respectively, before the indicated steady state input conditions were established.}$

 Q_{An} , Q_{Gn} = The level of Q_A or Q_G before the most recent \uparrow transition of the clock; indicated a one-bit shift.

Absolute Maximum Ratings(Note 1)

(Note 2)

Supply Voltage (V _{CC})	-0.5 to +7.0V
DC Input Voltage (V _{IN})	-1.5 to V_{CC} +1.5V
DC Output Voltage (V _{OUT})	-0.5 to V_{CC} +0.5 V
Clamp Diode Current (I _{IK} , I _{OK})	±20 mA
DC Output Current, per pin (I _{OUT})	±25 mA
DC V_{CC} or GND Current, per pin (I_{CC})	±50 mA
Storage Temperature Range (T _{STG})	-65°C to +150°C
Power Dissipation (P _D)	
(Note 3)	600 mW
S.O. Package only	500 mW
Lead Temperature (T _L)	

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V _{CC})	2	6	V
DC Input or Output Voltage			
(V_{IN}, V_{OUT})	0	V_{CC}	V
Operating Temperature Range (T_A)	-40	+85	°C
Input Rise or Fall Times			
$(t_r, t_f) V_{CC} = 2.0V$		1000	ns
$V_{CC} = 4.5V$		500	ns
$V_{CC} = 6.0V$		400	ns
Note 4. About to Manhaman Budgan and there		and the second second second	-11

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: – 12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 4)

(Soldering 10 seconds)

Symbol	Parameter	Conditions	V _{CC}	T _A = 25°C		$T_A = -40 \text{ to } 85^{\circ}\text{C}$	$T_A = -55 \text{ to } 125^{\circ}\text{C}$	Units
Symbol	raiametei	Conditions	▼CC	Typ Guaranteed Limits		imits	Units	
V _{IH}	Minimum HIGH Level		2.0V		1.5	1.5	1.5	V
	Input Voltage		4.5V		3.15	3.15	3.15	V
			6.0V		4.2	4.2	4.2	V
V _{IL}	Maximum LOW Level		2.0V		0.5	0.5	0.5	V
	Input Voltage		4.5V		1.35	1.35	1.35	V
			6.0V		1.8	1.8	1.8	V
V _{OH}	Minimum HIGH Level	$V_{IN} = V_{IH}$ or V_{IL}						
	Output Voltage	$ I_{OUT} \le 20 \ \mu A$	2.0V	2.0	1.9	1.9	1.9	V
			4.5V	4.5	4.4	4.4	4.4	V
			6.0V	6.0	5.9	5.9	5.9	V
		$V_{IN} = V_{IH}$ or V_{IL}						
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	4.2	3.98	3.84	3.7	V
		$ I_{OUT} \le 5.2 \text{ mA}$	6.0V	5.7	5.48	5.34	5.2	V
V _{OL}	Maximum LOW Level	$V_{IN} = V_{IH}$ or V_{IL}						
	Output Voltage	$ I_{OUT} \le 20 \ \mu A$	2.0V	0	0.1	0.1	0.1	V
			4.5V	0	0.1	0.1	0.1	V
			6.0V	0	0.1	0.1	0.1	V
		$V_{IN} = V_{IH}$ or V_{IL}						
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	0.2	0.26	0.33	0.4	V
		$ I_{OUT} \le 5.2 \text{ mA}$	6.0V	0.2	0.26	0.33	0.4	V
I _{IN}	Maximum Input	$V_{IN} = V_{CC}$ or GND	6.0V		±0.1	±1.0	±1.0	μА
	Current							
I _{CC}	Maximum Quiescent	$V_{IN} = V_{CC}$ or GND	6.0V		8.0	80	160	μΑ
	Supply Current	$I_{OUT} = 0 \mu A$						

260°C

Note 4: For a power supply of 5V \pm 10% the worst case output voltages (V_{OH} , and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at $V_{CC} = 5.5V$ and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN} , I_{CC} , and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

 $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

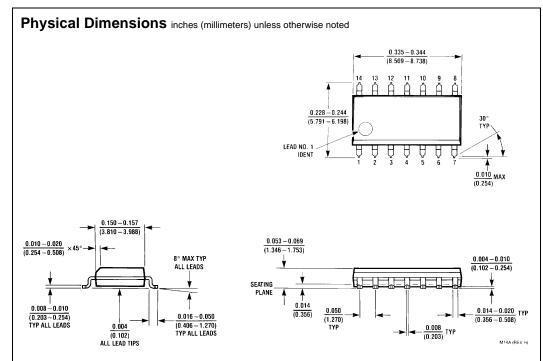
Symbol	Parameter	Conditions	Тур	Guaranteed	Units
			-71	Limit	
f _{MAX}	Maximum Operating			30	MHz
	Frequency				
t _{PHL} , t _{PLH}	Maximum Propagation		19	30	ns
	Delay, Clock to Output				
t _{PHL} , t _{PLH}	Maximum Propagation		23	35	ns
	Delay, Clear to Output				
t _{REM}	Minimum Removal Time,		-2	0	ns
	Clear to Clock				
t _S	Minimum Setup Time		12	20	ns
	Data to Clock				
t _H	Minimum Hold Time		1	5	ns
	Clock to Data				
t _W	Minimum Pulse Width		10	16	ns
	Clear or Clock				

AC Electrical Characteristics

 $\mathrm{C_L} = 50~\mathrm{pF},~\mathrm{t_f} = \mathrm{t_f} = 6~\mathrm{ns}$ (unless otherwise specified)

Symbol	Parameter	Conditions	v _{cc}	$T_A = 25^{\circ}C$		$T_A = -40 \text{ to } 85^{\circ}\text{C}$	$T_A = -55$ to $125^{\circ}C$	Units
Symbol				Тур		Guaranteed Limits		
f _{MAX}	Maximum Operating		2.0V		5	4	3	MHz
	Frequency		4.5V		27	21	18	MHz
			6.0V		31	24	20	MHz
t _{PHL} , t _{PLH}	Maximum Propagation		2.0V	115	175	218	254	ns
	Delay, Clock to Output		4.5V	13	35	44	51	ns
			6.0V	20	30	38	44	ns
t _{PHL} , t _{PLH}	Maximum Propagation		2.0V	140	205	256	297	ns
	Delay, Clear to Output		4.5V	28	41	51	59	ns
			6.0V	24	35	44	51	ns
t _{REM}	Minimum Removal Time		2.0V	-7	0	0	0	ns
	Clear to Clock		4.5V	-3	0	0	0	ns
			6.0V	-2	0	0	0	ns
t _S	Minimum Setup Time		2.0V	25	100	125	150	ns
	Data to Clock		4.5V	14	20	25	30	ns
			6.0V	12	17	21	25	ns
t _H	Minimum Hold Time		2.0V	-2	5	5	5	ns
	Clock to Data		4.5V	0	5	5	5	ns
			6.0V	1	5	5	5	ns
t _W	Minimum Pulse Width		2.0V	22	80	100	120	ns
	Clear or Clock		4.5V	11	16	20	24	ns
			6.0V	10	14	18	20	ns
t _{THL} , t _{TLH}	Maximum Output		2.0V		75	95	110	ns
	Rise and Fall Time		4.5V		15	19	22	ns
			6.0V		13	16	19	ns
t _r , t _f	Maximum Input Rise and Fall		2.0V		1000	1000	1000	ns
	Time		4.5V		500	500	500	ns
			6.0V		400	400	400	ns
C _{PD}	Power Dissipation Capacitance (Note 5)	(per package)	5.0V	150				pF
C _{IN}	Maximum Input Capacitance			5	10	10	10	pF

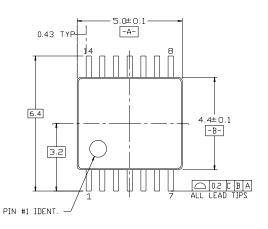
Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC}^2 \ f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC} \ f + I_{CC}$.

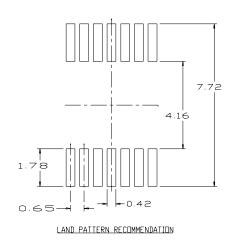


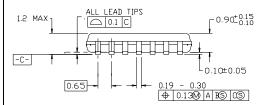
14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow Package Number M14A

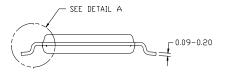
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

14LD, TSSOP, JEDEC MO-153, 4.4MM WIDE



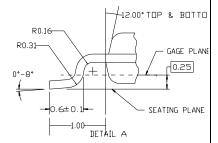






NOTES

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB., REF NOTE 6, DATED 7/93
- B. DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS



14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

Physical Dimensions inches (millimeters) unless otherwise noted (Continued) 0.740 - 0.770(18.80 - 19.56)0.090 (2.286) 14 13 12 11 10 9 8 14 13 12 INDEX 0.250 ± 0.010 (6.350 ± 0.254) PIN NO. 1 IDENT PIN NO. 1 1 2 3 4 5 6 7 1 2 3 $\frac{0.092}{(2.337)}$ DIA $\frac{0.030}{(0.762)}$ MAX OPTION 1 OPTION 02 $\frac{0.135 \pm 0.005}{(3.429 \pm 0.127)}$ 0.300 - 0.320(7.620 - 8.128)0.065 0.145 - 0.200 0.060 TYP 4° TYP (1.651) $\frac{3.143 - 5.280}{(3.683 - 5.080)}$ (1.524) 95°±5° $\frac{0.008 - 0.016}{(0.203 - 0.406)}$ TYP 0.020 (0.508)0.125 - 0.150 0.075 ± 0.015 $\overline{(3.175 - 3.810)}$ 0.280 (7.112)-MIN $\frac{0.014-0.023}{(0.356-0.584)}\, TYP$ $\frac{0.100 \pm 0.010}{(2.540 \pm 0.254)} \text{ TYP}$

14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

 0.050 ± 0.010

(1.270 - 0.254)

TYP

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- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

 $0.325 ^{\,+\,0.040}_{\,-\,0.015}$

 $8.255 + 1.016 \\ -0.381$

N14A (REV F)

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